IPC ASSOCIATION ELECTRONIC	© Copyright 200	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights res international and Pan-American copyright conventions.		all rights reserved un	nder both Tl	This document is a declaration of the substances within the manufacturer listed level parts, the declaration encompasses all lower level materials for which the					er listed ite	m. Note: i inufacturei	f the item is an as r has engineering	sembly with low responsibility.	
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ous Materia	ls and Mfg	g Informati	ion	
upplie	r Information								·						
Company name* Company				ny unique ID			Unique ID Authority					Response Date*			
n Semic	onductor											2021-02-04			
Contact N	Name		Title - Contact			P	Phone - Contact*					Email - Contact*			
Product-l	Env-Stewards		Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative			P	Phone - Representative*				Email - Representative*				
Product-	Env-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Ite		n Number Mfr Item Name				Effective Date	ective Date Version Manufacturing Si		ng Site	W	eight*	UOM	Unit Type	
		MC74HC164ADR2G LOG CMOS		LOG CMOS SHIF	HIFT REG 8BIT		2021-02-04 P		PH1		12	22.04	mg	Each	
Ianufa	acturing Process Inform														
	8		,		-STD-020 MSL F	Rating		ess Body Temperature Max Time at Peak		ne at Peak 7			er of Reflow Cyc	eles	
	Matte Tin (Sn) - annealed	(CU Alloy	1	-		260		C	30		second	s 3		
omments															
	naximum time at peak temper														
or more	information regarding mater	ial composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an						
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the co	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not e at least as comprehensive as the hts and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the				
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.98	mg	Supplier	Silicon (Si)	7440-21-3		0.98	mg
Die Attach	4.44	mg	Supplier	Silver (Ag)	7440-22-4		3.33	mg
			Supplier	Epoxy resins	129915-35-1		1.11	mg
Lead Frame	69.62	mg	Supplier	Silver (Ag)	7440-22-4		0.7658	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1392	mg
			Supplier	Iron (Fe)	7439-89-6		1.8101	mg
			Supplier	Copper (Cu)	7440-50-8		66.9048	mg
Mold Compound-Black	43.43	mg		Phenolic Resin	proprietary data		2.1715	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.8686	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		2.1715	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2172	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.0013	mg
Plating	3.27	mg	Supplier	Tin (Sn)	7440-31-5		3.27	mg
Wire Bond - Cu	0.3	mg	Supplier	Copper (Cu)	7440-50-8		0.3	mg